SANYO Semiconductors

DATA SHEET

LV5806MX — Step-down Switching Regulator

Overview

LV5806MX is a 1ch step-down switching regulator. 0.13Ω FET is incorporated on the upper side to achieve high-efficiency operation for large output current. Low-heat resistance and compact-package MFP8 (with Heat sink) employed. Current mode control type, with superior load current response and easy phase compensation ON/OFF pin, allowing the standby mode with the current drain of 100μ A Pulse-by-pulse over-current protection and overheat protection available for protection of load devices Soft start pin to be provided with a capacitance for soft start.

Functions

- 3A 1ch step-down switching regulator
- Wide input dynamic range (to 28V)
- High efficiency : 90% ($I_{OUT} = 1A$, $V_{IN} = 12V$, $V_O = 5V$)
- Standby mode
- Over-current protection

Applications

- LCD TV.
- Pre-regulator of linear regulator

- Thermal shutdown
- Reference voltage : 0.8V
- Fixed frequency : 370kHz
- Soft start
- Compact package : MFP8 (200mil) with Heat sink
- Power supply for χDSL
- Amusement

Specifications

Absolute Maximum Ratings at Ta = 25°C

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Parameter	Symbol	Conditions	Ratings	Unit
Maximum input V _{IN} voltage	V _{IN} max		32	V
BOOT pin maximum voltage	V _{BT} max		37	V
SW pin maximum voltage	V _{SW} max		V _{IN} max	V
BOOT pin-SW pin maximum voltage	V _{BS-SW} max		7	V
FB, EN, COMP, SS pin maximum voltage	Vfs max		7	V

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Parameter	Symbol	Conditions	Ratings	Unit
Allowable power dissipation	Pd max	With specified substrate *	2.05	W
Junction temperature	Tj max		150	°C
Operating temperature	Topr		-20 to +80	°C
Storage temperature	Tstg		-40 to +150	°C

* Specified substrate : 46.4mm × 31.8mm × 1.7mm, glass epoxy substrate

Note : Plan the maximum voltage while including coil and surge voltages, so that the maximum voltage is not exceeded even for an instant.

Recommended Operating Conditions at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
V _{IN} pin voltage	VIN		8 to 28	V
BOOT pin voltage	V _{BT}		-0.3 to 34	V
SW pin voltage	VSW		-0.4 to V _{IN}	V
BOOT pin-SW pin maximum voltage	V _{BS-SW}		6.5	V
FB, EN, COMP, SS pin voltage	V _{FSO}		6	V

Electrical Characteristics at Ta = 25°C, V_{IN} = 12V, unless otherwise specified.

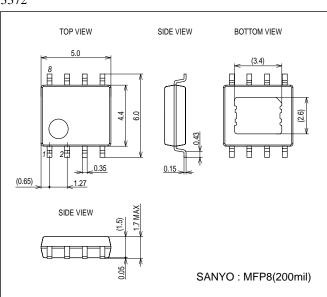
Parameter	Symbol Conditions	Ratings				
	Symbol	Symbol Conditions	min	typ	max	Unit
IC current drain at standby	I _{CC} 1	EN = 0V		70		μΑ
IC current drain in operation	I _{CC} 2	EN = open, FB = 1V		5		mA
Efficiency	Effcy	$V_{IN} = 12V$, $I_{OUT} = 1A$, $V_O = 5V$, Design target *1		90		%
Reference voltage	Vref	V _{IN} = 8V to 28V (±2%)	-2%	0.8	+2%	V
FB pin bias current	Iref	FB = 0.8V application		10	100	nA
High-side ON resistance	RonH	BOOT = 5V		0.13		Ω
Low-side ON resistance	RonL			6		Ω
Oscillation frequency	fosc		296	370	444	kHz
Oscillation frequency during short-circuit protection	foscs		26	32	39	kHz
EN high-threshold voltage	Venh				1.9	V
EN low-threshold voltage	Venl		0.8			V
EN pull-up current	len	EN = 0V		16		μA
Maximum ON DUTY	D max			80		%
Current limit peak value 1	Icl1	V _{IN} = 12V, V _{OUT} = 5V, L = 10μH	4			Α
Thermal shutdown temperature	Ttsd	Design guarantee *2		160		°C
Thermal shutdown temperature hysteresis	Dtsd	Design guarantee *2		40		°C
Soft start current	ISS	SS = 0V	6	10	14	μA

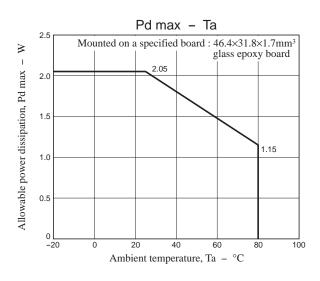
*1 : Reference value (not tested before shipment)

*2 : Design guarantee (value guaranteed by design and not tested before shipment)

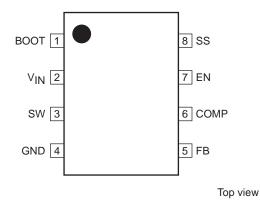
Package Dimensions

unit : mm (typ) 3372 www.DataSheet4U.com

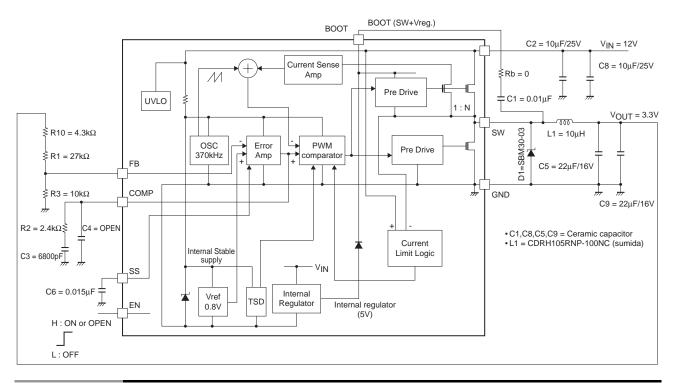




Pin Assignment



Block Diagram and Sample Application Circuit (3.3V output)

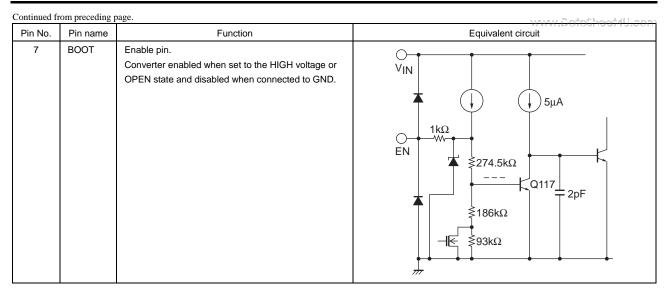


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Pin Function

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Pin No.	Pin name	Function	Equivalent circuit
1	BOOT	 Upper MOS transistor boot strap capacitance connection pin. Connect the boot capacitance of about 0.022μF between SW pins. To protect the SW pin's absolute maximum rating, to ensure stable operation, and to eliminate noise, the boot capacitance serial resistance (about 100Ω) Rb proves effective. Considerations for design : Insertion of serial beads in the Schottky diode to eliminate noise may cause occurrence of the negative voltage beyond the absolute maximum rating at the SW pin, resulting in failure of normal operation. Accordingly, eliminate noise not by inserting above beads, but by means of the BOOT 	→ VIN → CBOOT → E → Hi side MOS
2	V _{IN}	resistance. Input voltage pin. Connect substantially large (20µF or more)	OSW I
3	SW	capacitance between this pin and GND. Power switch pin. Connect the output LC filter. Connect the above capacitance between this pin and BOOT pin.	
4	GND	Ground pin.	
5	FB	Feedback pin. Sets the output voltage by means of split resistor in the section of the output voltage V _{OUT} - FB - GND. V _{OUT} setting is made as calculated below : $V_{OUT} = Vref \times \{1 + \frac{(R1 + R10)}{R3}\}$ Vref = 0.8V Example : 3.3V output voltage (See Block Diagram and Sample Application Circuit) $V_{OUT} = 0.8 \times \{1 + \frac{(27k + 4.3k)}{10k}\}$ = 3.304V	VIN VIN Internal regulation line
8	SS	Soft start pin. Sets the soft start time by means of the built-in 10µA source voltage and external soft start capacity. The soft start capacity C6 can be set as follows : $C6 = 10\mu A \times \frac{Tss}{Vref}$ Where, Tss is the soft start time and Vref is the reference voltage. Example : 1.2ms soft start time achieved $C6 = 10\mu A \times \frac{1.2msec}{0.8V} = 0.015\mu F$	FB
6	COMP	Phase compensation pin. Connects with the phase compensation external capacitance and resistance of DCDC converter close loop.	VIN Internal regulation line

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Considerations for the design

• Insertion of serial beads in the Schottky diode for removal of noise may cause generation of the negative voltage deviating from the absolute maximum rating at the SW pin, resulting in failure of normal operation. In such an event, do not insert beads as above described and, instead, remove noise by means of the BOOT resistance Rb.

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